

REMARKS

This submission accompanies an RCE, which requests consideration of a Supplemental Information Disclosure Statement ("IDS"). The Supplemental IDS contains references cited or issued in other co-pending patent applications or patents.

For the Office's convenience, Applicants identify in Table 1 below certain co-pending applications and patents, including filing date, assignment, and inventor information. Applicant provides herewith Exhibit 1, which contains all of the claims of the listed applications and patents. Applicant submits these claims for the Office's convenience in evaluating any potential issues regarding statutory or obviousness-type double patenting.

Attorney Docket No.	U.S. Patent Application No.	U.S. Filing Date/371(c) Date	First Named Inventor	Title	Assignment Recorded (Reel, Frame, Date)	Publication Date
04208.0146-00000	10/153,638 - now USPN 6,739,894	05/24/02	Masaru SATO	SOCKET FOR IC PACKAGE	012934/0114 Recorded - 05/24/2002	11/28/02
04208.0151-00000	10/161,641 now USPN 6,758,684	06/05/02	Takahiro OIKAWA	IC SOCKET	012964/0707 Recorded - 06/05/02	12/12/02
04208.0158-00000	10/212,875 now USPN 6,752,645	08/07/02	Yuji NAKAMURA	SEMICONDUCTOR DEVICE-SOCKET HAVING ROTATIONALLY MOVABLE HEAT SINKS	013178/0359 Recorded - 08/07/02	02/13/03
04208.0217-00000	11/106,461	04/15/05	Ryo UJIKE	SEMICONDUCTOR DEVICE SOCKET	016484/0913 Recorded - 04/15/05	Not yet published

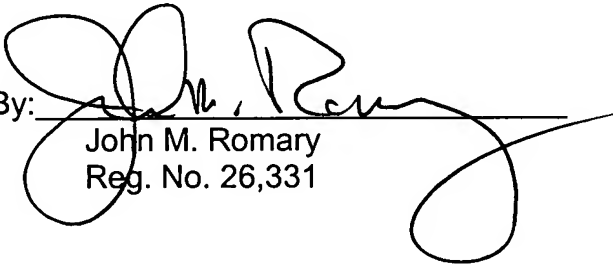
Attorney Docket No.	U.S. Patent Application No.	U.S. Filing Date/371(c) Date	First Named Inventor	Title	Assignment Recorded (Reel, Frame, Date)	Publication, Date
04208.0222- 00000	11/212,706	08/29/05	Masaru SATO	METHOD OF MOUNTING AND DEMOUNTING A SEMICONDUCTOR DEVICE, DEVICE FOR MOUNTING AND DEMOUNTING A SEMICONDUCTOR DEVICE USING THE SAME, AND SOCKET FOR A SEMICONDUCTOR DEVICE	Not yet assigned	Projected publication date is 03/02/06

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW,
GARRETT & DUNNER, L.L.P.

Dated: February 28, 2005

By:


John M. Romary
Reg. No. 26,331

Attachments: Exhibit 1